TOSHIBA 2SJ537

TOSHIBA FIELD EFFECT TRANSISTOR SILICON P CHANNEL MOS TYPE (π -MOS \forall I)

2 S J 5 3 7

HIGH SPEED, HIGH CURRENT SWITCHING APPLICATIONS CHOPPER REGULATOR, DC-DC CONVERTER AND MOTOR DRIVE **APPLICATIONS**

Low Drain-Source On Resistance : $R_{DS(ON)} = 0.16 \Omega \text{ (Typ.)}$

High Forward Transfer Admittance : $|Y_{fS}| = 3.5 \text{ S}$ (Typ.)

Low Leakage Current : $I_{DSS} = -100 \,\mu\text{A} \,(V_{DS} = -50 \,\text{V})$

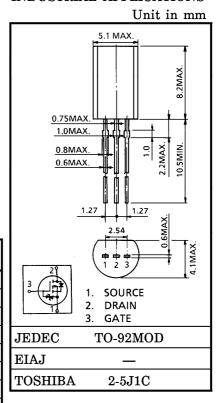
Enhancement-Mode : $V_{th} = -0.8 \sim -2.0 V$

 $(V_{DS} = -10 \text{ V}, I_{D} = -1 \text{ mA})$

MAXIMUM RATINGS (Ta = 25°C)

CHARACTERI	SYMBOL	RATING	UNIT	
Drain-Source Voltage	$v_{ m DSS}$	-50	V	
Drain-Gate Voltage (Re	$v_{ m DGR}$	-50	V	
Gate-Source Voltage	v_{GSS}	±20	V	
Droin Current	DC	$I_{\mathbf{D}}$	- 5	Α
Drain Current	Pulse	I_{DP}	-15	Α
Drain Power Dissipation	$P_{\mathbf{D}}$	0.9	W	
Channel Temperature	$\mathrm{T_{ch}}$	150	°C	
Storage Temperature R	$\mathrm{T_{stg}}$	-55~150	$^{\circ}\mathrm{C}$	

INDUSTRIAL APPLICATIONS



THERMAL CHARACTERISTICS

CHARACTERISTIC	SYMBOL	MAX.	UNIT
Thermal Resistance, Channel to Ambient	R _{th (ch-a)}	138	°C/W

This transistor is an electrostatic sensitive device. Please handle with caution.

The information contained herein is subject to change without notice.

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ELECTRICAL CHARACTERISTICS (Ta = 25°C)

CHARA	CTERISTIC	SYMBOL	TEST CONDITION	MIN.	TYP.	MAX.	UNIT
Gate Leakag	e Current	IGSS	$V_{GS} = \pm 16 \text{ V}, V_{DS} = 0 \text{ V}$	_	_	±10	μ A
Drain Cut-of	f Current	$I_{ m DSS}$	$V_{DS} = -50 \text{ V}, V_{GS} = 0 \text{ V}$	_	_	-100	μ A
Drain-Source Voltage	Breakdown		$I_{D} = -10 \text{ mA}, V_{GS} = 0 \text{ V}$	-50	_	_	V
Gate Thresh	old Voltage	$V_{ m th}$	$V_{DS} = -10 V, I_{D} = -1 mA$	-0.8	_	-2.0	V
Drain-Source	ON Resistance	R _{DS} (ON)	$V_{GS} = -4 \text{ V}, I_{D} = -1.3 \text{ A}$ $V_{GS} = -10 \text{ V}, I_{D} = -2.5 \text{ A}$	_	0.27 0.16	0.34 0.19	Ω
Forward Tra Admittance	nsfer	Y _{fs}	$V_{DS} = -10 \text{ V}, I_{D} = -2.5 \text{ A}$	1.5	3.5	_	S
Input Capacitance		$\mathrm{c_{iss}}$		_	470	_	
Reverse Transfer Capacitance		C_{rss}	$V_{DS} = -10 \text{ V}, V_{GS} = 0 \text{ V},$ f = 1 MHz	_	60	_	рF
Output Capacitance		Coss		_	210	_	1
Switching Time	Rise Time	t _r	$^{0\mathrm{V}}$ $^{\mathrm{I}_{\mathrm{D}}} = -2.5\mathrm{A}$	_	25	_	
	Turn-on Time	t _{on}	V_{GS} V	_	35	_	ns
	Fall Time	tf		_	20	_	115
	Turn-off Time	t _{off}	$V_{\mathrm{DD}} = -25 \mathrm{V}$ $V_{\mathrm{IN}} : t_{\mathrm{r}}, t_{\mathrm{f}} < 5 \mathrm{ns},$ $v_{\mathrm{DD}} = -25 \mathrm{V}$ $v_{\mathrm{DU}} = -25 \mathrm{V}$ $v_{\mathrm{DU}} = -25 \mathrm{V}$ $v_{\mathrm{DU}} = -25 \mathrm{V}$	_	120	_	
Total Gate Charge (Gate-Source Plus Gate-Drain)		$\mathbf{Q_g}$	$V_{DD} = -40 \text{ V}, V_{GS} = -10 \text{ V},$	_	18	_	
Gate-Source Charge		$\mathbf{Q}_{\mathbf{g}\mathbf{s}}$	$I_{\mathrm{D}} = -5 \mathrm{A}$	_	13	_	nC
Gate-Drain ("Miller") Charge		\mathbf{Q}_{gd}		_	5	—	

SOURCE-DRAIN DIODE RATINGS AND CHARACTERISTICS (Ta = 25°C)

CHARACTERISTIC	SYMBOL	TEST CONDITION	MIN.	TYP.	MAX.	UNIT
Continuous Drain Reverse Current	$I_{ m DR}$	_	_	_	-5	A
Pulse Drain Reverse Current	$I_{ m DRP}$	_	_	_	-15	A
Diode Forward Voltage	${ m v_{DSF}}$	$I_{DR} = -5 \text{ A}, V_{GS} = 0 \text{ V}$	_	_	1.5	V

MARKING

